

Variant: 001
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PMP23653-XFMR REV A Bill of Materials



Item #	Designator	Quantity	Value	PartNumber	Manufacturer	Description	PackageReference
1	PCB1	1		PMP23653-XFMR	Any	Printed Circuit Board	
2	CORE1	1		B66483G0000X149	TDK	EQ20 core set, N49 material, gapped to 1.1uH	
3	CORE2	1		B66483K0000X149	TDK	I core set, N49 material, gapped to 1.1uH	
4	J3	1		SLV W 1 080 6 G		Connector Header Through Hole 6 position 0.050" (1.27mm)	
5	J5, J7	2		SLV W 4 080 6 G		Connector Header Through Hole 6 position 0.050" (1.27mm)	